TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC237AP, TC74HC237AF

3-to-8 Line Decoder/Latch

The TC74HC237A is a high speed CMOS 3-to-8 LINE DECODER ADDRESS LATCH fabricated with silicon gate C2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

It is composed of a 3-bit input latches with a common $\overline{\mathrm{GL}}$ enable input and 3-to-8 line decoder with enable inputs G1 and $\overline{\mathrm{G2}}$. The 3-bit binary data is stored into the input latch on the high level of $\overline{\mathrm{GL}}$. The value of this data determines which one of the outputs will go low.

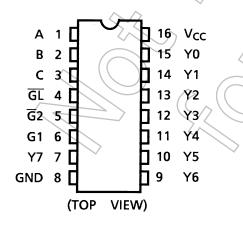
When the enable input G1 is held low or $\overline{G2}$ is held high, decoding function is inhibited and all the 8 outputs go high. The two enable inputs are provided to ease cascade connection and permits the application address decoder for memory system.

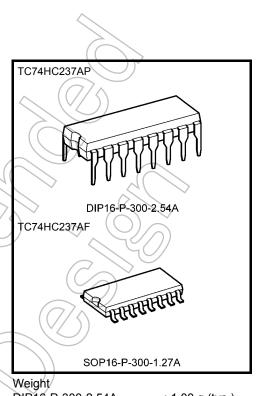
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: t_{pd} = 12 ns (typ.) at V_{CC} = 5 V
- Low power dissipation: $I_{CC} = 4 \ \mu A \ (max)$ at $Ta = 25^{\circ}C$
- High noise immunity: $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}}$ (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS237

Pin Assignment





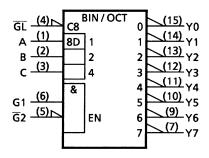
DIP16-P-300-2.54A SOP16-P-300-1.27A

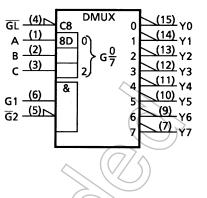
: 1.00 g (typ.) : 0.18 g (typ.)

Start of commercial production 1988-05

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IEC Logic Symbol



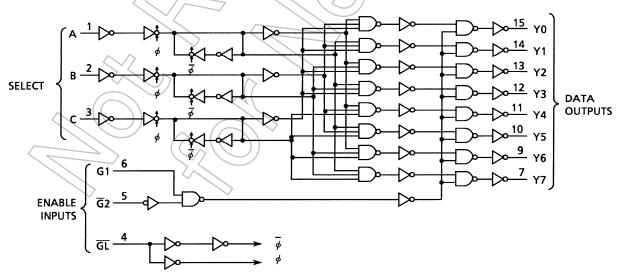


Truth Table

	Inputs								Out	puts 🤇		2		
	Enable			Address	;	YO	Y1	Y2	Y3	Y4	Y5	Y6	YT	
GL	G2	G1	С	В	А	ΥŪ	Ϋ́Ι	٢Z	13 <	1 (14	719	TO	1	
Х	Х	L	Х	Х	Х	L	L	L	5		L	L	14	$\langle \rangle$
Х	Н	Х	Х	Х	Х	L	L	L))	L) L (O)/	à
L	L	Н	L	L	L	Н	L	4	L.	L	L	<i>f</i>	, LL	
L	L	Н	L	L	Н	L	Н	K	2	L	L	25	7)	
L	L	Н	L	Н	L	L	L	H	Z	L	L		L	
L	L	Н	L	Н	Н	L	6	4	РН	L	(7)	\	L	
L	L	Н	Н	L	L	L		2	L	Ŧ	Ľ	Ŋг	L	
L	L	Н	Н	L	Н	L	Ļ	$>_{L}$	K	L) H	L	L	
L	L	Н	Н	Н	L	F	L	L	L	4))L	Н	L	
L	L	Н	Н	Н	Н	A		L	L		/ L	L	Н	
н	L	Н	х	х	×	Depen	ds upon	the add		viously a w level	applied	while G	L was	

X: Don't care

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	Vout	–0.5 to V _{CC} + 0.5	V
Input diode current	Ік	±20	mA
Output diode current	Іок	±20	(mA)
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	VOUT	0 to V _{CC}	V
Operating temperature	Topr	-40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Operating Ranges (Note)

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol			Ta = 25°C			Ta = -40 to 85°C		Unit	
			$V_{CC}(V)$	Min	Тур.	Max	Min	Max		
				2.0	1.50	_	À	1.50	_	V
High-level input voltage	VIH		—	4.5	3.15	—	(=)	3.15	—	
				6.0	4.20		\mathcal{A}	4.20		
				2.0	>	-67	0.50	0.50 —	0.50	v
Low-level input voltage	VIL		_	4.5	_	\sum	1.35	—	1.35	
Ĵ		_		6.0	-(((+)	1.80		1.80	
	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	_	1.9	_	
				4.5	4.4	4.5	—	4.4	_	
High-level output voltage				6.0	5.9	6.0	/	5.9	\searrow	V
_			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	-6	4.13	$\geq -$	
			I _{OH} = -5.2 mA	6.0	5.68	5.80		5.63) —	
				2.0	_	0.0	0.1	Z	0.1	
			$I_{OL} = 20 \ \mu A$	4.5	—	0.0	0.1	~_	0.1	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}		6.0	_	0.0	0.1		0.1	V
_			$I_{OL} = 4 \text{ mA}$	4.5	—	0.17 <	0.26	—	0.33	
			I _{OL} = 5.2 mA	6.0		0.18	0.26		0.33	
Input leakage current	I _{IN}	$V_{IN} = V_{CC} \text{ or GND}$		6.0	-		±0.1	_	±1.0	μΑ
Quiescent supply current	ICC	VIN = V _{CC} or	GND	6.0	\geq	/_	4.0	_	40.0	μΑ

Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta =	25°C	Ta = -40 to 85°C	Unit
		$\langle \langle \rangle \rangle$	V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulso width	_		2.0	_	75	95	
Minimum pulse width	t _{W (L)}		4.5	—	15	19	ns
			6.0	—	13	16	
Minimum set-up time	\wedge		2.0	_	50	65	
(A, B, C- \overline{GL})	ts	—	4.5	—	10	13	ns
(A, B, C-GL)		\supset	6.0	—	9	11	
Minimum hold time	(())		2.0		25	30	
	th	—	4.5	—	5	6	ns
(A, B, C-GL)			6.0		5	5	

AC Characteristics (C_L = 15 pF, V_{CC} = 5 V, Ta = 25°C, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Тур.	Max	Unit
Output transition time	t _{TLH}			4	8	ns
	t _{THL}			-	0	115
Propagation delay time	t _{pLH}	4	/	12	24	20
(G1-Y)	t _{pHL}		\geq	12	24	ns
Propagation delay time	t _{pLH}		(()	12	24	20
(<u>G</u> 2 -Y)	t _{pHL}	_			24	ns
Propagation delay time	t _{pLH}	\sim (2	$\langle \gamma \rangle$	17	33	20
(<u>GL</u> -Y)	t _{pHL}		T	17	33	ns
Propagation delay time	t _{pLH}		>	15	31	20
(A, B, C-Y)	t _{pHL}	-		15	31	ns

AC Characteristics ($C_L = 50 \text{ pF}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = -40 to 85°C			Unit	
			Vcc (V)	Min	Тур.	Max	Min	Max	
	t _{TLH}	40	2.0	—	30	75	~ —	95	
Output transition time			4.5	_	8	_15	_	19	ns
	t _{THL}		6.0	_		13	_	16	
Propagation delay	t _{pLH}		2.0		45	140	—	175	
time			4.5	`	15	28	—	35	ns
(G1-Y)	t _{pHL}	(\bigcirc)	6.0	$\left \right\rangle$	13	24	—	30	
Propagation delay	+		2.0	1	45	140	—	175	
time	t _{pLH} t	$(\bigcirc \frown \frown \frown$	4.5	—	15	28	—	35	ns
(G 2 -Y)	t _{pHL}		6.0	<u> </u>	13	24	—	30	
Propagation delay	t	7/5	2.0	_	65	190	—	240	
time	tpLH	\mathcal{O} – $\overline{\mathcal{O}}$	4.5	_	21	38	—	48	ns
(<u>GL</u> -Y)	tpнL))6.0	_	18	32	—	41	
Propagation delay			2.0	_	60	180	_	225	
time		$\langle E_{\perp} \rangle$	4.5	_	19	36	—	45	ns
(A, B, C-Y)	t _{pHL}		6.0	—	16	31	—	38	
Input capacitance	G IN			_	5	10		10	pF
Power dissipation capacitance	C _{PD} (Note)	-			52	—	—		pF

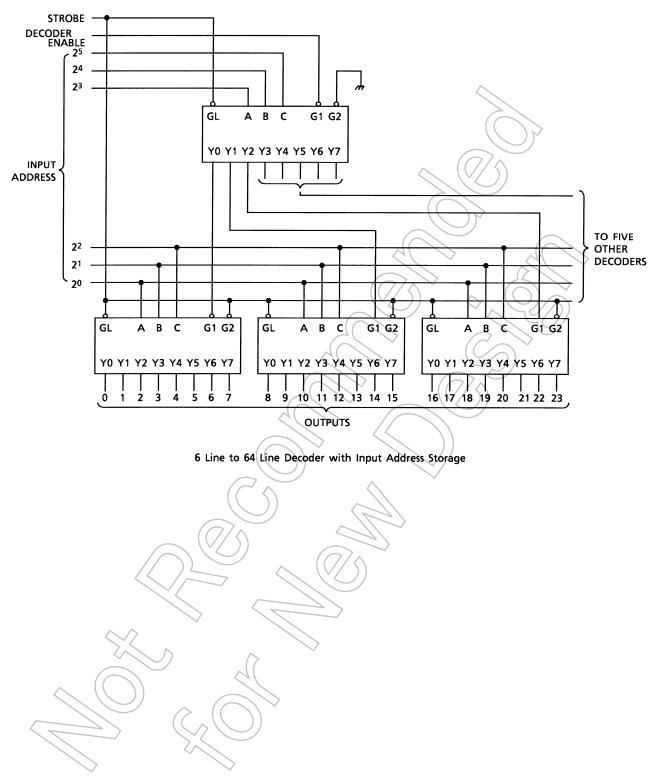
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC} \text{ (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

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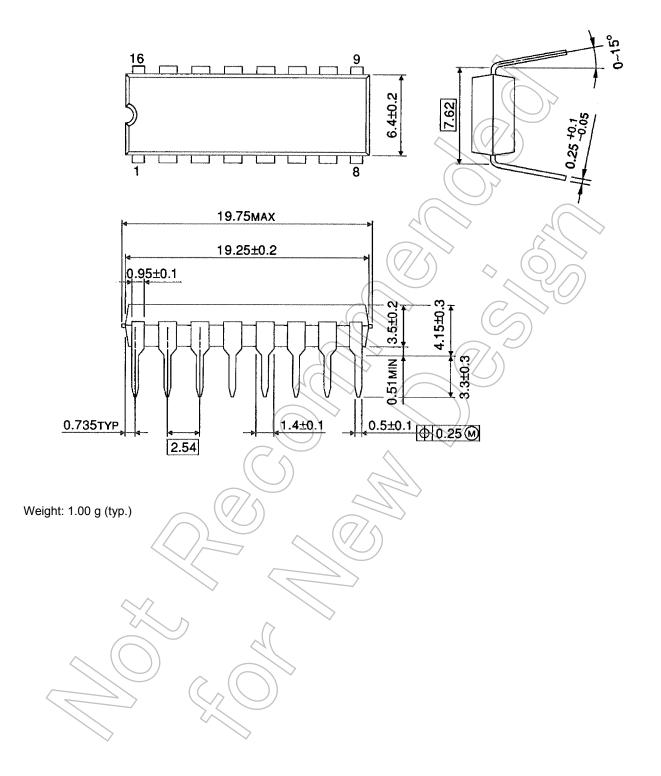
Typical Application



Package Dimensions

DIP16-P-300-2.54A

Unit : mm

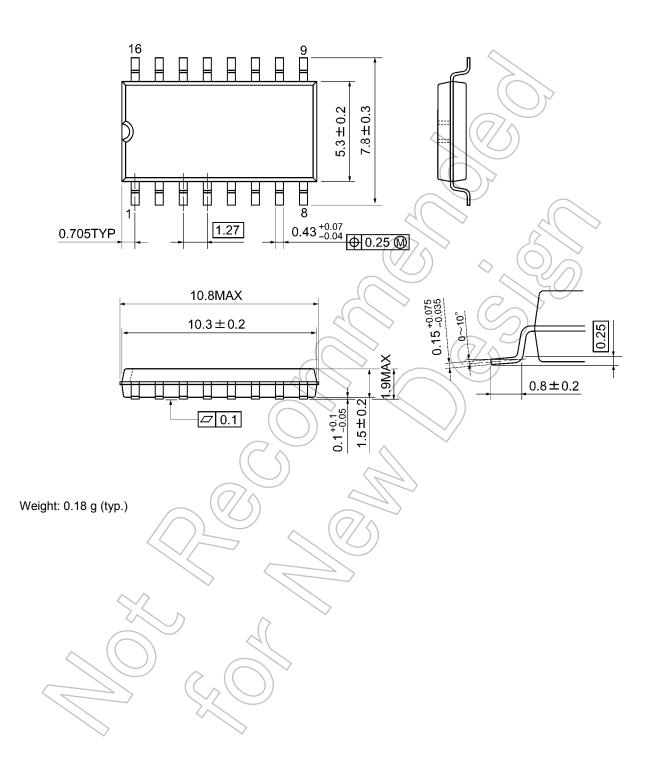




Package Dimensions

SOP16-P-300-1.27A

Unit: mm



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